### **STF23N80K5**



# N-channel 800 V, 0.23 Ω typ., 16 A MDmesh™ K5 Power MOSFET in a TO-220FP package

Datasheet - production data

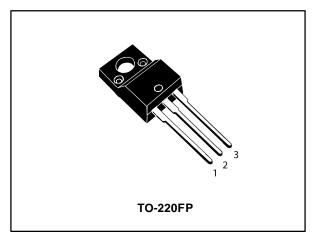
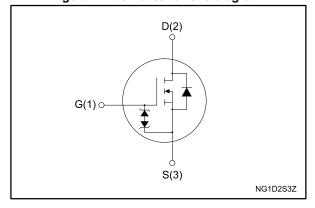


Figure 1: Internal schematic diagram



### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ΙD	Ртот
STF23N80K5	800 V	0.28 Ω	16 A	35 W

- Industry's lowest R<sub>DS(on)</sub> x area
- Industry's best figure of merit (FoM)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### **Description**

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

**Table 1: Device summary** 

Order code	Marking	Package	Packing
STF23N80K5	23N80K5	TO-220FP	Tube

Contents STF23N80K5

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STF23N80K5 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>G</sub> s	Gate-source voltage	±30	V
I_	Drain current (continuous) at T <sub>case</sub> = 25 °C	16	Α
l <sub>D</sub>	Drain current (continuous) at T <sub>case</sub> = 100 °C	10	A
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	64	Α
P <sub>TOT</sub>	Total dissipation at T <sub>case</sub> = 25 °C	35	W
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	4.5	V/ns
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	50	V/IIS
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s;Tc= 25 °C)		V
T <sub>stg</sub>	Storage temperature	-55 to 150	°C
Tj	Operating junction temperature	-33 10 130	J

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	3.6	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5	C/VV

**Table 4: Avalanche characteristics** 

Symbol	Parameter	Value	Unit	
I <sub>AR</sub> <sup>(1)</sup>	I <sub>AR</sub> <sup>(1)</sup> Avalanche current, repetitive or not repetitive			
Eas <sup>(2)</sup>	Single pulse avalanche energy	400	mJ	

#### Notes:

 $<sup>^{(1)}</sup>$  Pulse width is limited by safe operating area.

 $<sup>^{(2)}</sup>$  IsD  $\leq$  16 A, di/dt=100 A/µs; VDs peak < V(BR)DSS, VDD = 80% V(BR)DSS.

 $<sup>^{(3)}</sup>$  V<sub>DS</sub>  $\leq 640$  V

 $<sup>^{(1)}</sup>$  Pulse width limited by  $T_{jmax}$ .

 $<sup>^{(2)}</sup>$  starting  $T_j = 25~^{\circ}C,~I_D = I_{AR},~V_{DD} = 50~V.$ 

Electrical characteristics STF23N80K5

### 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

Table 5: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			V
		$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	
I <sub>DSS</sub> Zero gate voltage current		V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 800 V, T <sub>case</sub> = 125 °C			50	μΑ
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 100 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A		0.23	0.28	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	1000	•	
Coss	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	65	ı	pF
Crss	Reverse transfer capacitance	V <sub>GS</sub> = 0 V	-	1.5	-	P1
C <sub>O(tr)</sub> <sup>(1)</sup>	Equivalent output capacitance	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$ V	-	165	1	5.F
C <sub>O(er)</sub> <sup>(2)</sup>	Equivalent output capacitance	V <sub>DS</sub> = 0 to 640 V, V <sub>GS</sub> = 0 V	-	59	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I <sub>D</sub> = 0 A	-	4.7	•	Ω
$Q_g$	Total gate charge	V <sub>DD</sub> = 640 V, I <sub>D</sub> = 16 A, V <sub>GS</sub> = 10 V (see <i>Figure 14:</i> "Test circuit for gate charge	-	33	ı	
Qgs	Gate-source charge		-	6	-	nC
$Q_{gd}$	Gate-drain charge	behavior")	-	25	1	

#### Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 400 \text{ V}, I_D = 8 \text{ A}$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V} \text{ (see}$ Figure 13: "Test circuit for resistive load switching times"	ı	14	ı	
tr	Rise time		-	9	-	
t <sub>d(off)</sub>	Turn-off delay time		-	48	-	ns
t <sub>f</sub>	Fall time	and Figure 18: "Switching time waveform")	1	9	1	

 $<sup>^{(1)}</sup>$  Time related is defined as a constant equivalent capacitance giving the same charging time as  $C_{OSS}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

 $<sup>^{(2)}</sup>$  Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		16	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		64	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 16 A	-		1.5	<b>V</b>
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 16 A, di/dt = 100 A/µs, V <sub>DD</sub> = 60 V (see Figure 15: "Test circuit for inductive load	-	410		ns
Qrr	Reverse recovery charge		-	7		μC
I <sub>RRM</sub>	Reverse recovery current	switching and diode recovery times")	-	34		А
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 16 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	650		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C} \text{ (see}$ Figure 15: "Test circuit for	-	10		μC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	32		Α

#### Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	±30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

<sup>&</sup>lt;sup>(1)</sup> Pulse width is limited by safe operating area.

 $<sup>^{(2)}</sup>$  Pulse test: pulse duration = 300  $\mu$ s, duty cycle 1.5%.

## 2.1 Electrical characteristics (curves)

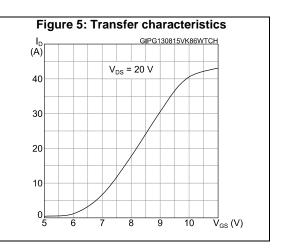
Figure 2: Safe operating area

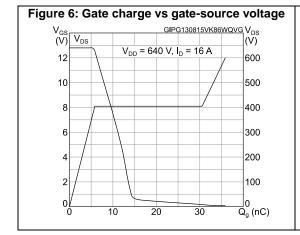
ID
(A)

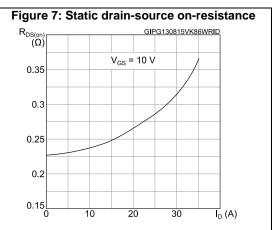
Operation in this area is

101

100 μs







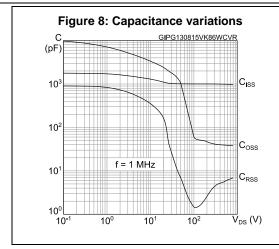


Figure 9: Normalized gate threshold voltage vs temperature

V<sub>GS(th)</sub>

GIPG130815VK86WVTH

(norm.)

1.2

1.0

0.8

0.6

0.4

0.2

-50

0 50

100

T<sub>j</sub>(°C)

Figure 10: Normalized on-resistance vs temperature

R<sub>DS(on)</sub> GIPG130815VK86WRON
(norm.)

2.6

2.2

1.8

1.4

1.0

0.6

0.2

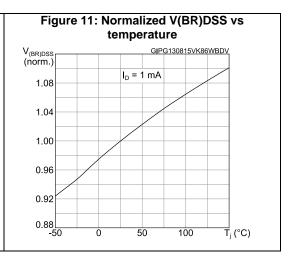
-50

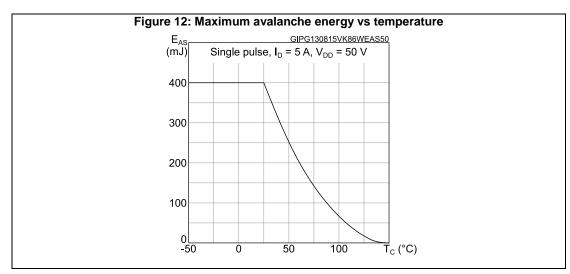
0

50

100

T<sub>j</sub> (°C)





Test circuits STF23N80K5

### 3 Test circuits

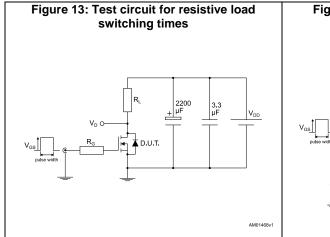
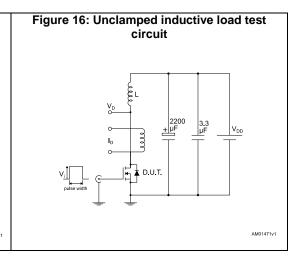


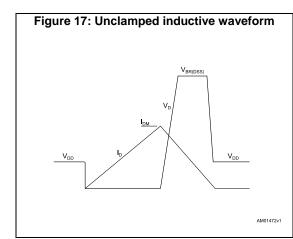
Figure 14: Test circuit for gate charge behavior

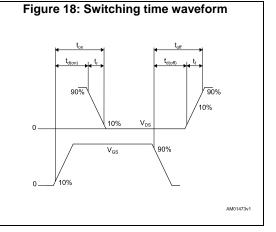
12 V 47 kΩ 100 nF D.U.T.

2200 VG

AM01468v1







STF23N80K5 Package information

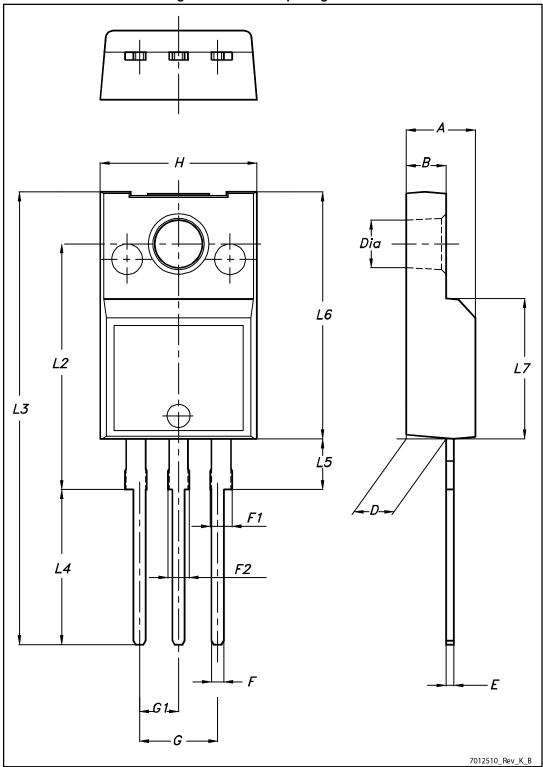
## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



# 4.1 TO-220FP package information

Figure 19: TO-220FP package outline



STF23N80K5

Table 10: TO-220FP package mechanical data

Di		mm	
Dim.	Min.	Тур.	Max.
А	4.4		4.6
В	2.5		2.7
D	2.5		2.75
Е	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

Revision history STF23N80K5

# 5 Revision history

Table 11: Document revision history

Date	Revision	Changes
28-Aug-2015	1	First release.

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